

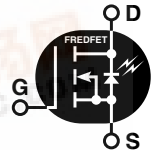
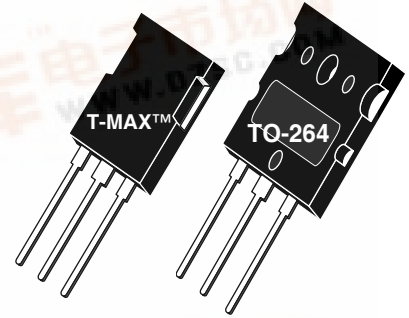


APT12060B2VFR APT12060LVFR

1200V 20A 0.600Ω

POWER MOS V[®]

Power MOS V[®] is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS V[®] also achieves faster switching speeds through optimized gate layout.



- **Faster Switching**
- **Lower Leakage**
- **Avalanche Energy Rated**
- **Popular T-MAX™ or TO-264 Package**

MAXIMUM RATINGS

All Ratings: T_C = 25°C unless otherwise specified.

| Symbol | Parameter | APT12060B2VFR_LVFR | UNIT |
|-----------------------------------|--|--------------------|-------|
| V _{DSS} | Drain-Source Voltage | 1200 | Volts |
| I _D | Continuous Drain Current @ T _C = 25°C | 20 | Amps |
| I _{DM} | Pulsed Drain Current ^① | 80 | |
| V _{GS} | Gate-Source Voltage Continuous | ±30 | Volts |
| V _{GSM} | Gate-Source Voltage Transient | ±40 | |
| P _D | Total Power Dissipation @ T _C = 25°C | 625 | Watts |
| | Linear Derating Factor | 5.00 | W/°C |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | -55 to 150 | °C |
| T _L | Lead Temperature: 0.063" from Case for 10 Sec. | 300 | |
| I _{AR} | Avalanche Current ^① (Repetitive and Non-Repetitive) | 20 | Amps |
| E _{AR} | Repetitive Avalanche Energy ^① | 50 | mJ |
| E _{AS} | Single Pulse Avalanche Energy ^④ | 3000 | |

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | MIN | TYP | MAX | UNIT |
|---------------------|--|------|-----|-------|-------|
| BV _{DSS} | Drain-Source Breakdown Voltage (V _{GS} = 0V, I _D = 250μA) | 1200 | | | Volts |
| R _{DS(on)} | Drain-Source On-State Resistance ^② (V _{GS} = 10V, I _D = 10A) | | | 0.600 | Ohms |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{DS} = 1200V, V _{GS} = 0V) | | | 250 | μA |
| | Zero Gate Voltage Drain Current (V _{DS} = 960V, V _{GS} = 0V, T _C = 125°C) | | | 1000 | |
| I _{GSS} | Gate-Source Leakage Current (V _{GS} = ±30V, V _{DS} = 0V) | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 1mA) | 2 | | 4 | Volts |

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

DYNAMIC CHARACTERISTICS

APT12060B2VFR_LVFR

| Symbol | Characteristic | Test Conditions | MIN | TYP | MAX | UNIT |
|---------------------|------------------------------|--|-----|------|------|------|
| C _{iss} | Input Capacitance | V _{GS} = 0V | | 7545 | 9500 | pF |
| C _{oss} | Output Capacitance | V _{DS} = 25V | | 650 | 980 | |
| C _{rss} | Reverse Transfer Capacitance | f = 1 MHz | | 350 | 490 | |
| Q _g | Total Gate Charge ③ | V _{GS} = 10V | | 431 | 650 | nC |
| Q _{gs} | Gate-Source Charge | V _{DD} = 0.5 V _{DSS} | | 34 | 41 | |
| Q _{gd} | Gate-Drain ("Miller") Charge | I _D = I _D [Cont.] @ 25°C | | 210 | 320 | |
| t _{d(on)} | Turn-on Delay Time | V _{GS} = 15V | | 13 | 26 | ns |
| t _r | Rise Time | V _{DD} = 0.5 V _{DSS} | | 12 | 24 | |
| t _{d(off)} | Turn-off Delay Time | I _D = I _D [Cont.] @ 25°C | | 63 | 95 | |
| t _f | Fall Time | R _G = 0.6Ω | | 12 | 25 | |

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | MIN | TYP | MAX | UNIT |
|------------------|--|------------------------|-----|-----|-------|
| I _S | Continuous Source Current (Body Diode) | | | 20 | Amps |
| I _{SM} | Pulsed Source Current ① (Body Diode) | | | 80 | |
| V _{SD} | Diode Forward Voltage ② (V _{GS} = 0V, I _S = -I _D [Cont.]) | | | 1.3 | Volts |
| dv/dt | Peak Diode Recovery dv/dt ③ | | | 18 | V/ns |
| t _{rr} | Reverse Recovery Time (I _S = -I _D [Cont.], di/dt = 100A/μs) | T _j = 25°C | | 320 | ns |
| | | T _j = 125°C | | 650 | |
| Q _{rr} | Reverse Recovery Charge (I _S = -I _D [Cont.], di/dt = 100A/μs) | T _j = 25°C | 3 | | μC |
| | | T _j = 125°C | 9 | | |
| I _{RRM} | Peak Recovery Current (I _S = -I _D [Cont.], di/dt = 100A/μs) | T _j = 25°C | 15 | | Amps |
| | | T _j = 125°C | 25 | | |

THERMAL CHARACTERISTICS

| Symbol | Characteristic | MIN | TYP | MAX | UNIT |
|------------------|---------------------|-----|-----|------|------|
| R _{θJC} | Junction to Case | | | 0.20 | °C/W |
| R _{θJA} | Junction to Ambient | | | 40 | |

① Repetitive Rating: Pulse width limited by maximum junction temperature.

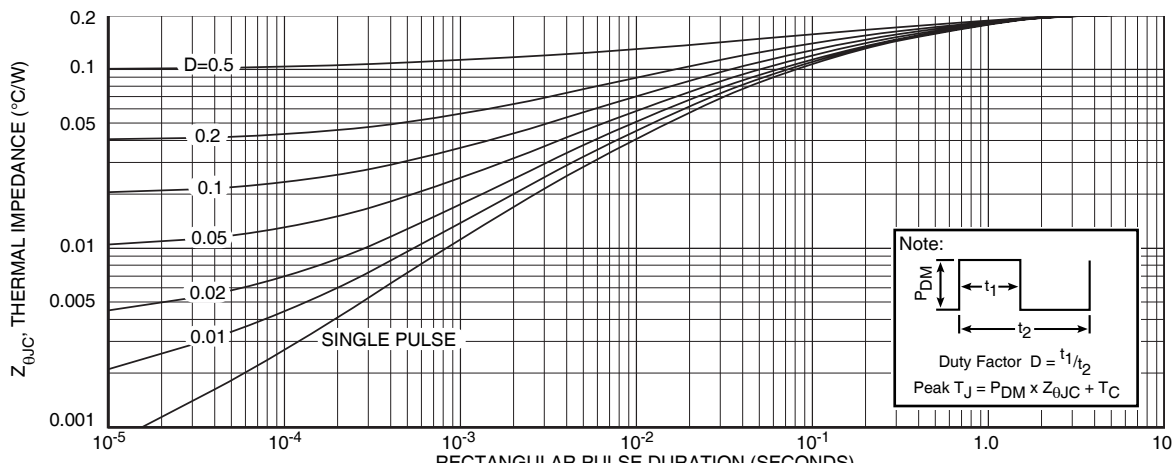
② Pulse Test: Pulse width < 380 μs, Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

④ Starting T_j = +25°C, L = 15mH, R_G = 25Ω, Peak I_L = 20A

⑤ I_S ≤ I_D [Cont.], di/dt = 100A/μs, T_j ≤ 150°C, R_G = 2.0Ω V_R = 200V.

APT Reserves the right to change, without notice, the specifications and information contained herein.



Typical Performance Curves

APT12060B2VFR_LVFR

Graph Deleted

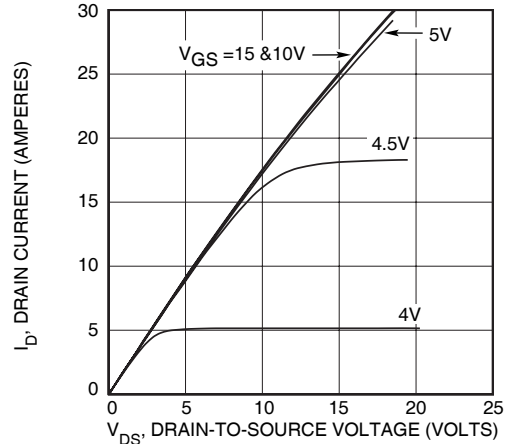


FIGURE 3, LOW VOLTAGE OUTPUT CHARACTERISTICS

FIGURE 2, HIGH VOLTAGE OUTPUT CHARACTERISTICS

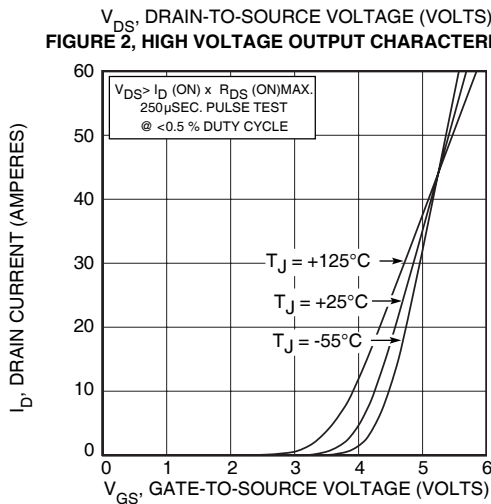


FIGURE 4, TRANSFER CHARACTERISTICS

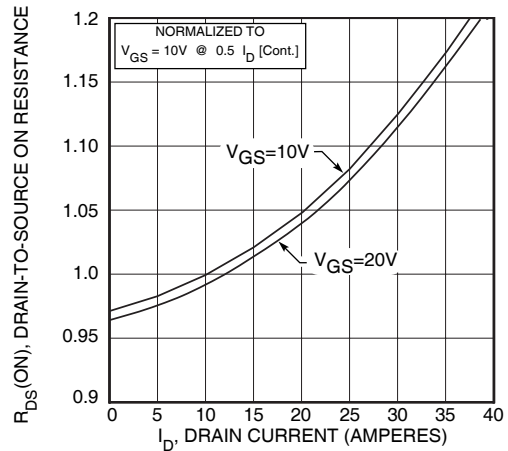


FIGURE 5, $R_{DS(ON)}$ vs DRAIN CURRENT

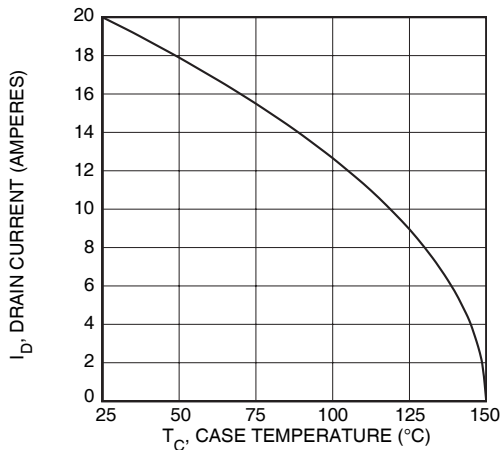


FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

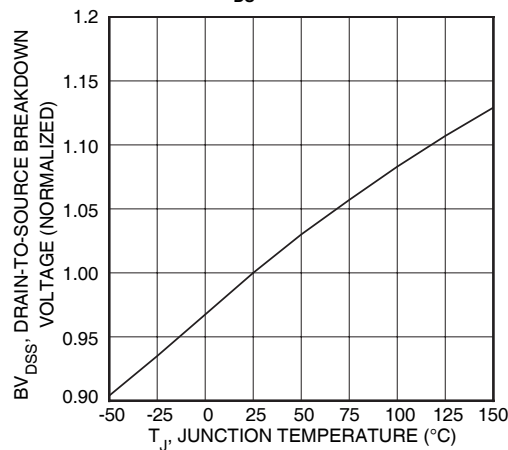


FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE

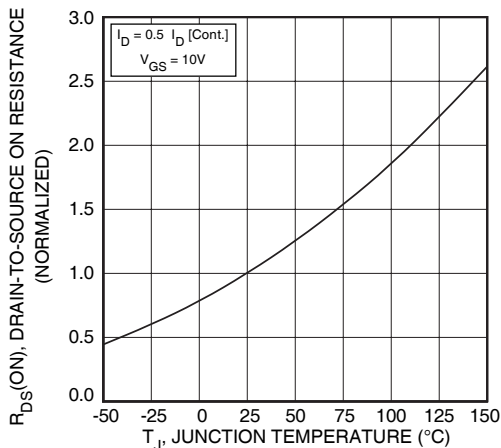


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

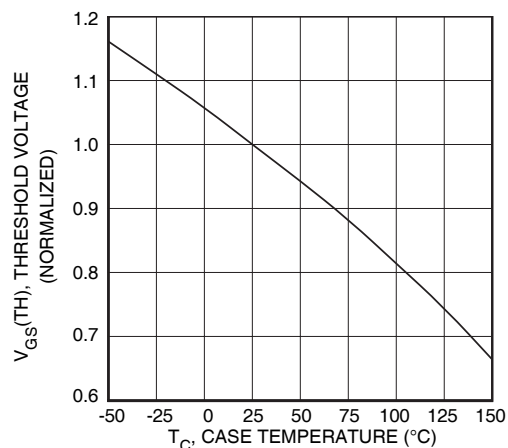


FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE

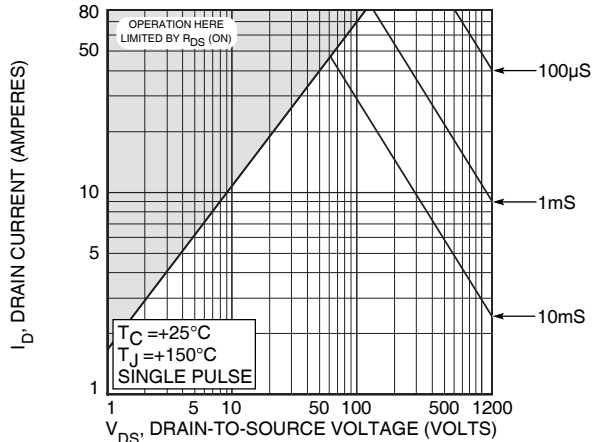


FIGURE 10, MAXIMUM SAFE OPERATING AREA

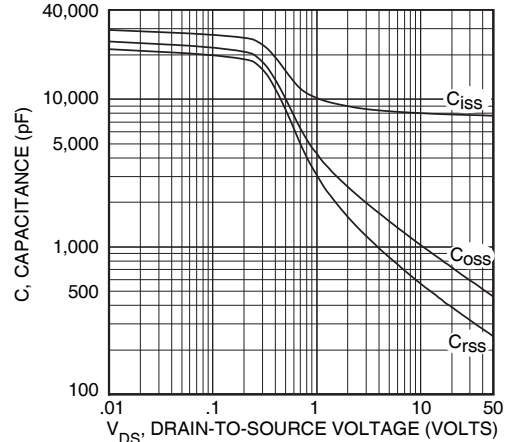


FIGURE 11, CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

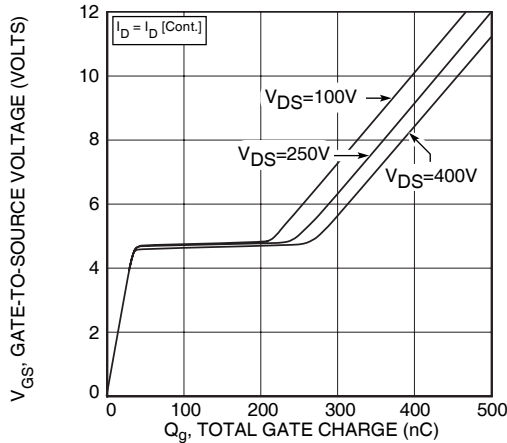


FIGURE 12, GATE CHARGE vs GATE-TO-SOURCE VOLTAGE

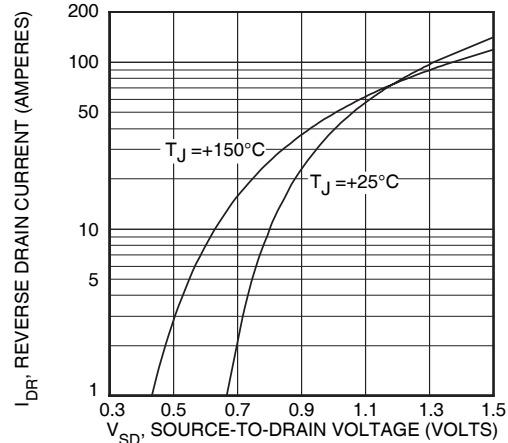
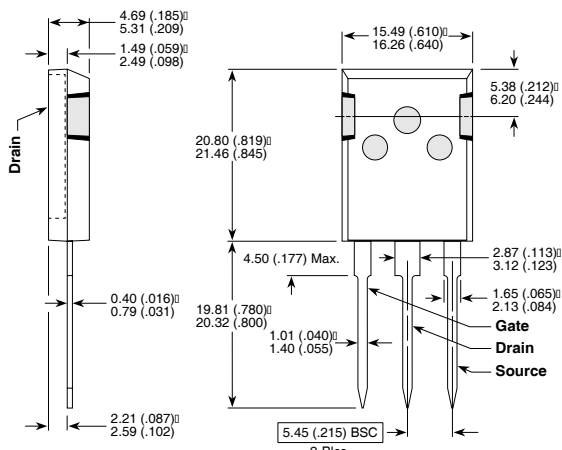


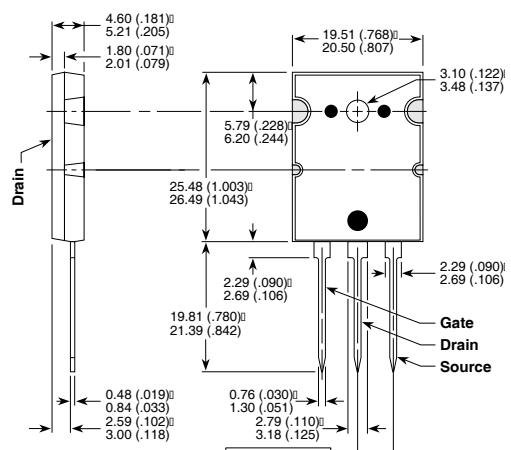
FIGURE 13, SOURCE-DRAIN DIODE FORWARD VOLTAGE

T-MAX™ (B2) Package Outline



These dimensions are equal to the TO-247 without the mounting hole.
Dimensions in Millimeters and (Inches)

TO-264 (L) Package Outline



Dimensions in Millimeters and (Inches)